

30V P-Channel Enhancement Mode MOSFET

Description

The NP20P03D6 G uses advanced trench technology to provide excellent $R_{DS(ON)}$. This device is suitable for use as a load switch or in PWM applications.

General Features

- ◆ $V_{DS} = -30V \quad I_D = -20A$
 $R_{DS(ON)}(\text{Typ.}) = 16m\Omega \quad @ V_{GS} = -10V$
 $R_{DS(ON)}(\text{Typ.}) = 21m\Omega \quad @ V_{GS} = -4.5V$
- ◆ High power and current handling capability
- ◆ Lead free product is acquired
- ◆ Surface mount package
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

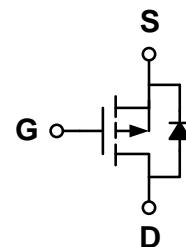
Application

- ◆ PWM applications
- ◆ Load switch
- ◆ Uninterruptible power supply

Package

- ◆ PDFN5*6-8L-A *100% UIS TESTED!*
100% ΔV_{ds} TESTED!

Schematic diagram

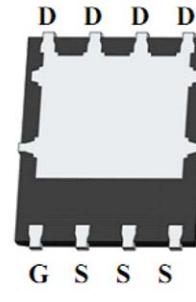


Marking and pin assignment

PDFN5*6-8L-A



Top View



Bottom View

XXXXX—Wafer Information

YYYYY—Quality Code



Ordering Information

| Part Number | Storage Temperature | Package | Devices Per Reel |
|-------------|---------------------|--------------|------------------|
| NP20P03D6-G | -55°C to +150°C | PDFN5*6-8L-A | 5000 |

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| parameter | symbol | limit | unit |
|--|----------|----------|------|
| Drain-source voltage | V_{DS} | -30 | V |
| Gate-source voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current TC=25°C | I_D | 20 | A |
| TC=70°C | | 16 | |
| Pulsed Drain Current | I_{DP} | 80 | A |
| Avalanche energy($T_j=25^\circ C$, $V_{DD}=30V$, $V_G=10V$, $L=0.5mH$, $R_g=25\Omega$) | E_{AS} | 170 | mJ |
| Power Dissipation TC=25°C | P_D | 31 | W |
| TC=70°C | | 15 | |
| Operating junction Temperature range | T_j | -55—150 | °C |

Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|---------------------|--|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | BV _{DSS} | V _{GS} =0V, I _D =-250μA | -30 | - | - | V |
| Zero gate voltage drain current | I _{DSS} | V _{DS} =-30V, V _{GS} =0V | - | - | 1 | μA |
| | | T _J =85°C | - | - | 30 | |
| Gate Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} =±20V | - | - | ±100 | nA |
| Gate threshold voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =-250μA | -1.2 | -1.6 | -2.5 | V |
| Drain-source on-state resistance ¹ | R _{DS(ON)} | V _{GS} =-10V, I _D =-20A | - | 16 | 21 | mΩ |
| | | V _{GS} =-4.5V, I _D =-15A | - | 21 | 26 | |
| On Status Drain Current | I _{D(ON)} | V _{DS} =-15V, V _{GS} =-10V | 25 | - | - | A |
| Diode Characteristics | | | | | | |
| Diode Forward Voltage ¹ | V _{SD} | I _{SD} =-20A, V _{GS} =0V | - | -0.8 | -1.3 | V |
| Diode Continuous Forward Current | I _S | | - | -25 | - | A |
| Reverse Recovery Time | t _{rr} | I _F =-20A, dI/dt=-100A/us | - | 24 | - | ns |
| Reverse Recovery Charge | Q _{rr} | | - | 16 | - | nC |
| Dynamic Characteristics² | | | | | | |
| Gate Resistance | R _G | V _{GS} =0V, V _{DS} =0V, f=1MHz | - | 0.65 | - | Ω |
| Input capacitance | C _{iss} | V _{GS} =0V, V _{DS} =-15V f=1.0MHz | - | 1360 | - | pF |
| Output capacitance | C _{oss} | | - | 250 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 210 | - | |
| Turn-on delay time | t _{D(ON)} | V _{GS} =-10V, V _{DD} =-30V, R _L =3Ω, I _D =20A, R _G =2.5Ω | - | 9 | - | ns |
| Turn-on Rise time | t _r | | - | 10 | - | |
| Turn-off delay time | t _{D(OFF)} | | - | 50 | - | |
| Turn-off Fall time | t _f | | - | 20 | - | |
| Total gate charge | Q _g | V _{GS} =-10V, I _D =-20A V _{DS} =-15V | - | 31 | - | nC |
| Gate-source charge | Q _{gs} | | - | 3 | - | |
| Gate-drain charge | Q _{gd} | | - | 9 | - | |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Unit |
|--|--------------|------------------|-----|------|
| Maximum Junction-to-Ambient ^A | ≤ 10s | R _{θJA} | 29 | °C/W |
| Maximum Junction-to-Ambient ^A | Steady-State | | 56 | |
| Maximum Junction-to-Lead ^B | Steady-State | | 3.2 | |
| | | | 4 | |

A: The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

Typical Performance Characteristics

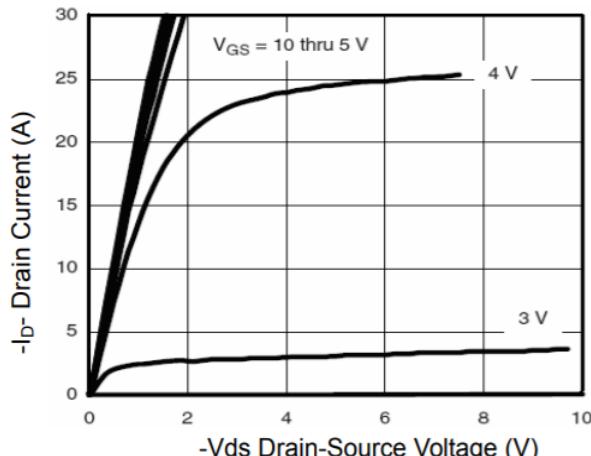


Figure 1 Output Characteristics

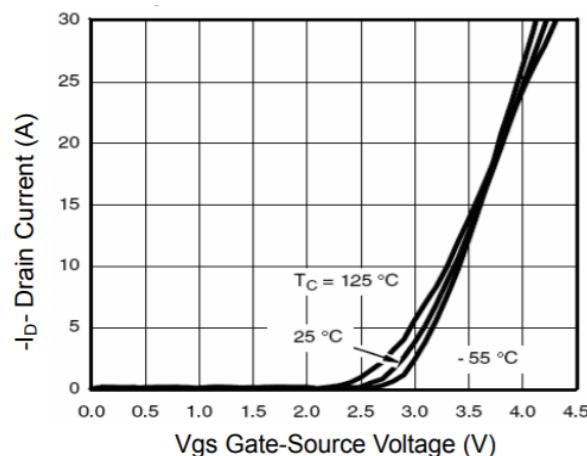


Figure 2 Transfer Characteristics

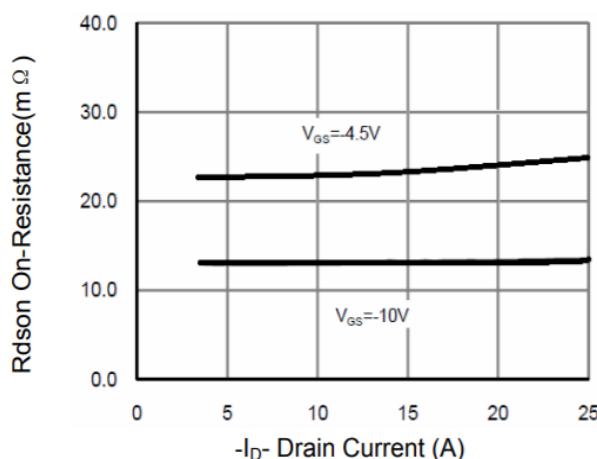


Figure 3 Rdson-Drain Current

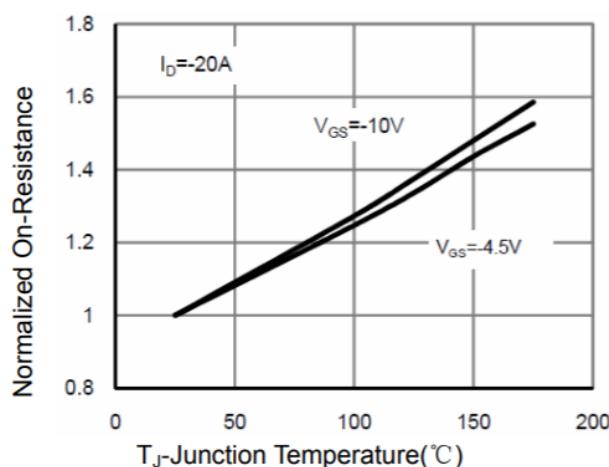


Figure 4 Rdson-Junction Temperature

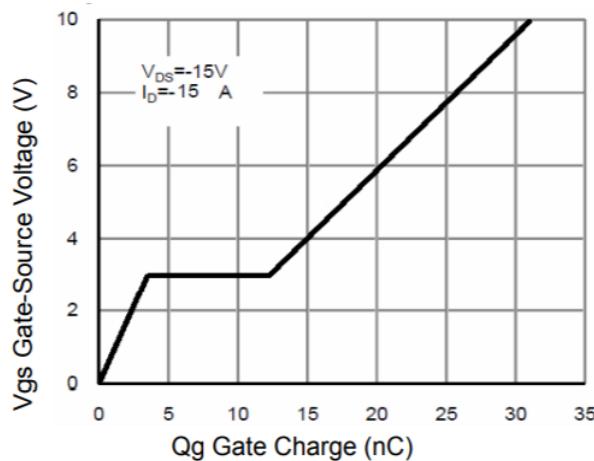


Figure 5 Gate Charge

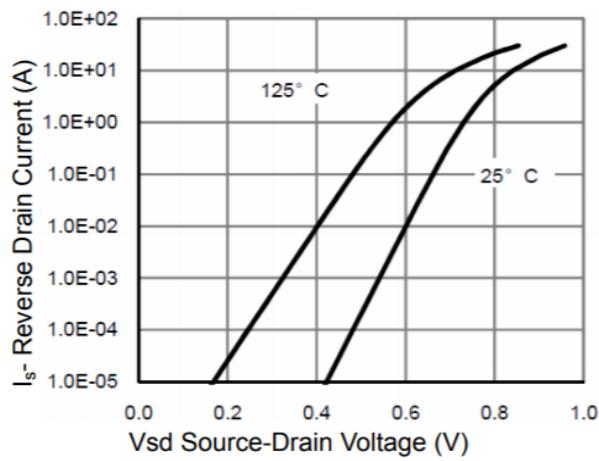


Figure 6 Source- Drain Diode Forward

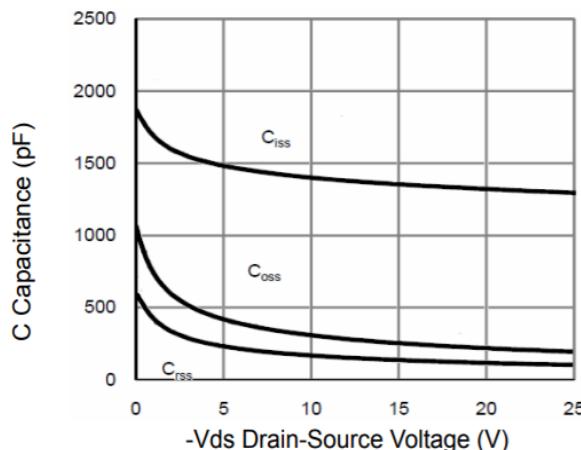
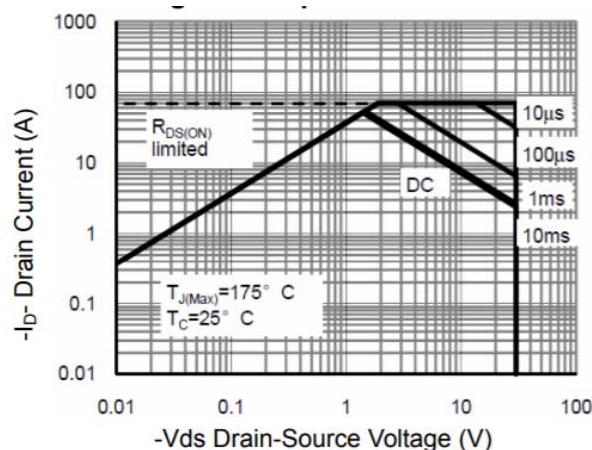
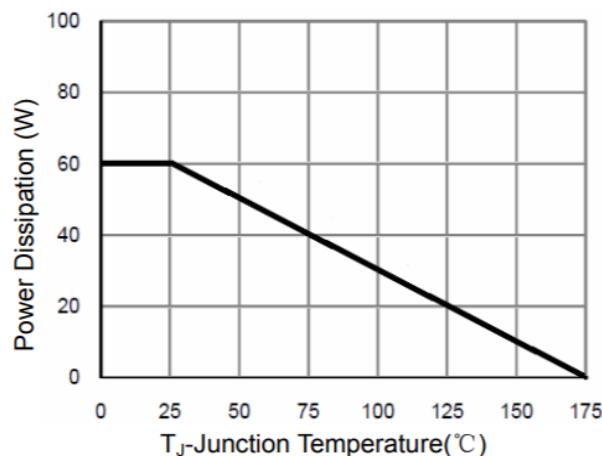
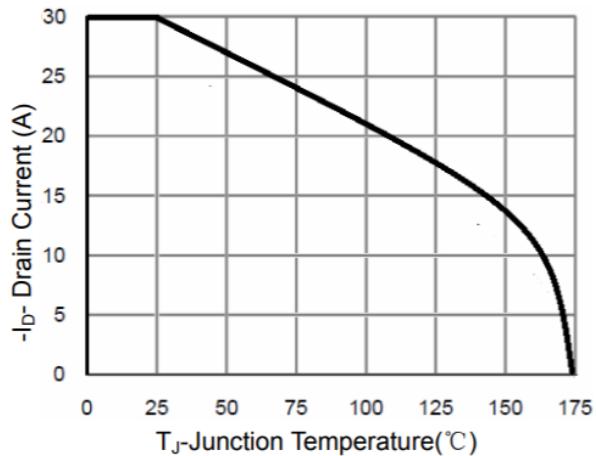
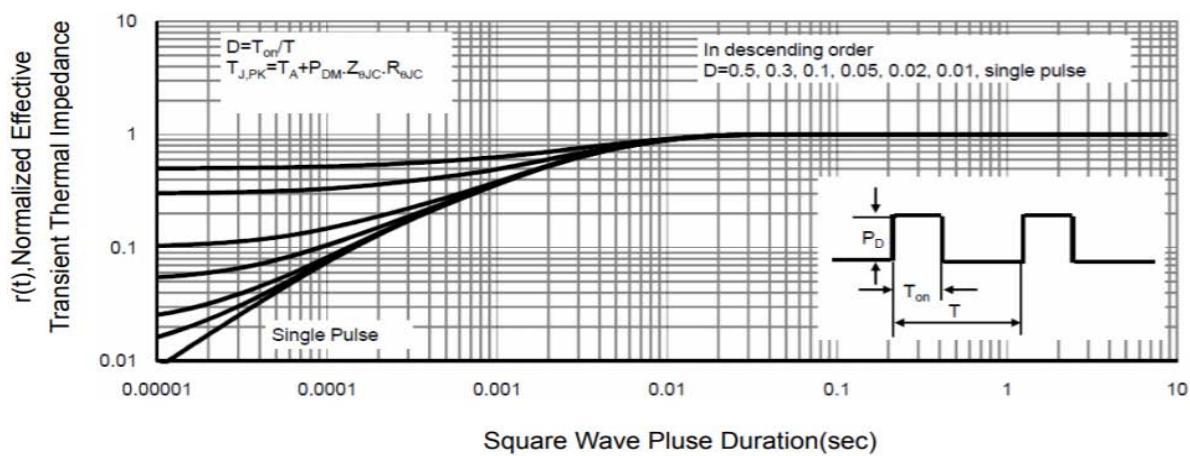

Figure 7 Capacitance vs Vds

Figure 8 Safe Operation Area

Figure 9 Power De-rating

Figure 10 ID Current Derating

Figure 11 Normalized Maximum Transient Thermal Impedance

Figure A: Gate Charge Test Circuit & Waveforms

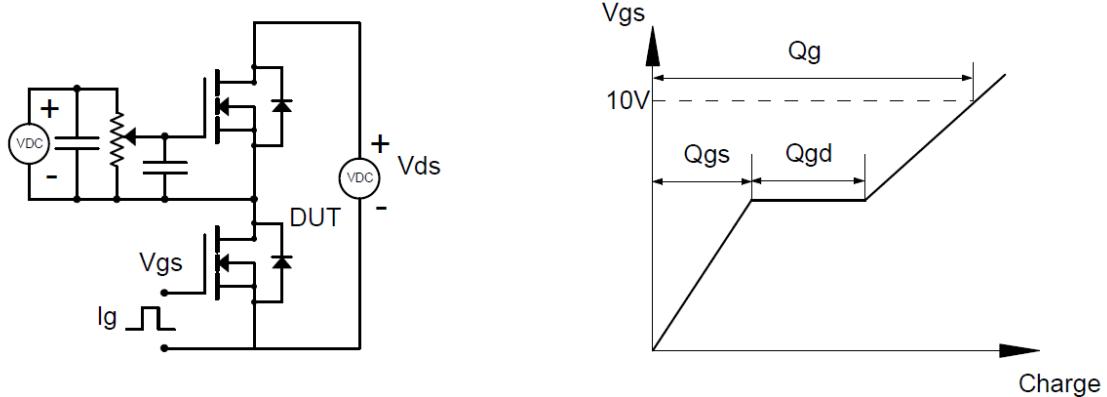


Figure B: Resistive Switching Test Circuit & Waveforms

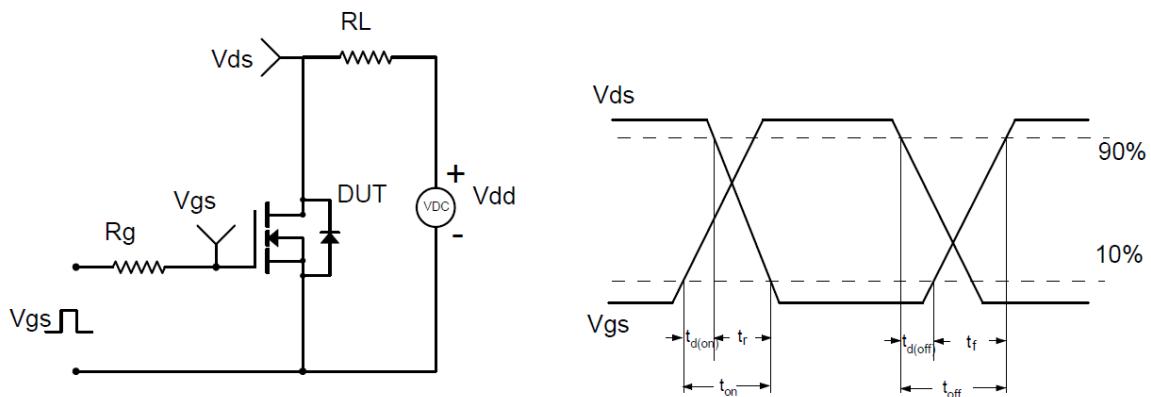


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

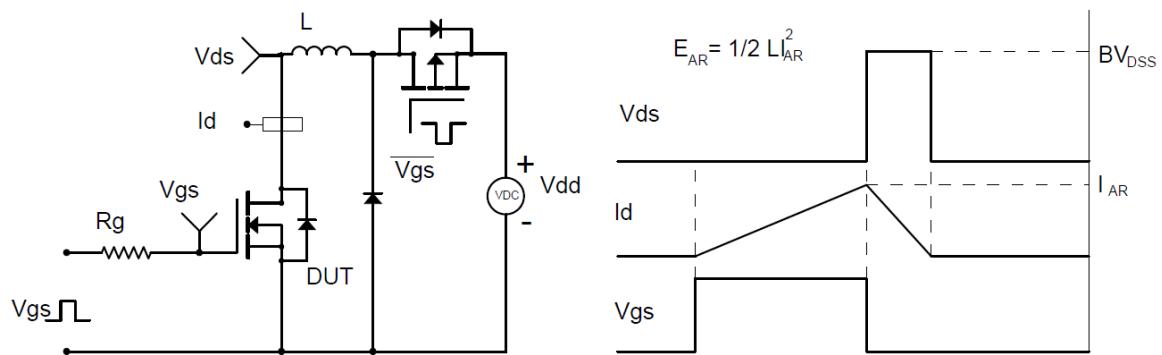
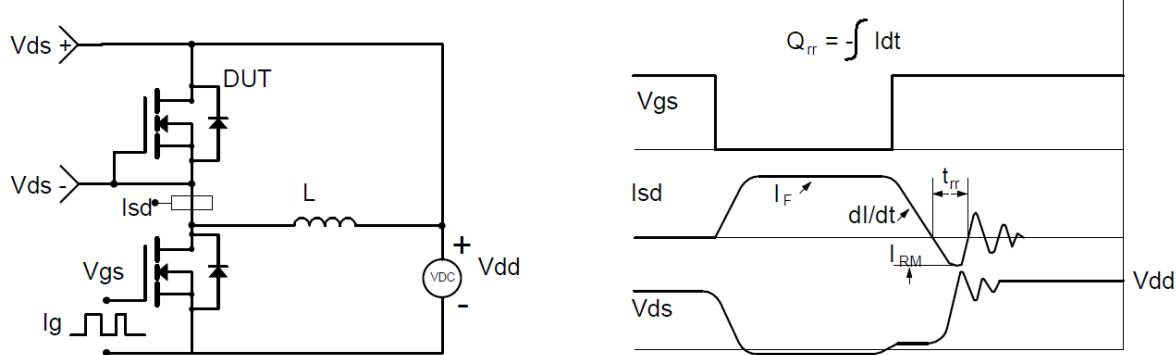


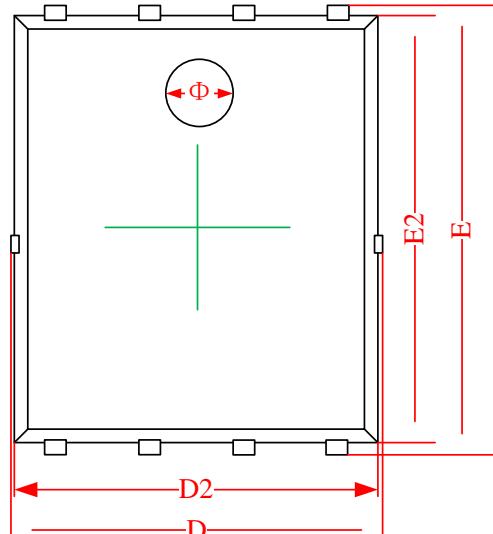
Figure D: Diode Recovery Test Circuit & Waveforms



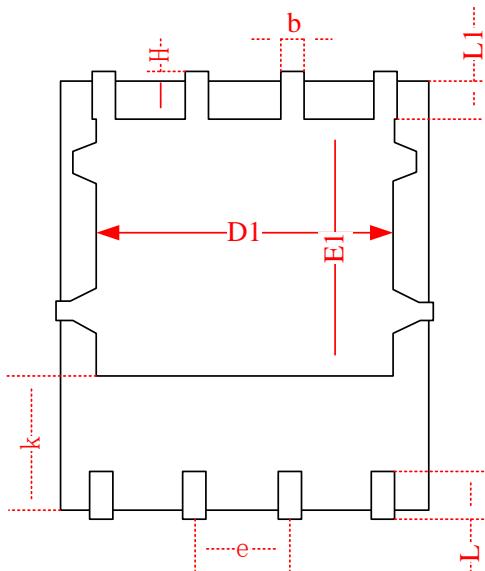
Package Information

- PDFN5*6-8L-A

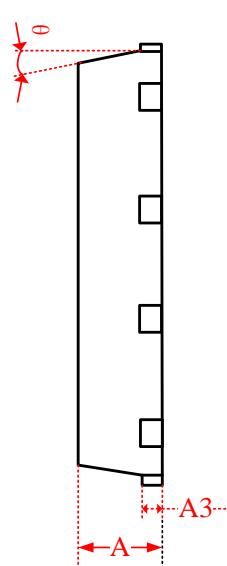
Top View



Bottom View



Side View



| SYMBOLS | DIMENSIONS IN MILLIMETERS | | | DIMENSIONS IN INCHES | | |
|----------|---------------------------|-------|-------|----------------------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.870 | 0.900 | 0.930 | 0.034 | 0.035 | 0.036 |
| A3 | 0.152REF. | | | 0.006REF. | | |
| D | 4.944 | 5.020 | 5.096 | 0.195 | 0.198 | 0.201 |
| E | 5.974 | 6.050 | 6.126 | 0.235 | 0.238 | 0.241 |
| D1 | 3.910 | 4.010 | 4.110 | 0.154 | 0.158 | 0.162 |
| E1 | 3.375 | 3.475 | 3.575 | 0.133 | 0.137 | 0.141 |
| D2 | 4.870 | 4.900 | 4.930 | 0.192 | 0.193 | 0.194 |
| E2 | 5.720 | 5.750 | 5.780 | 0.226 | 0.227 | 0.228 |
| k | 1.190 | 1.290 | 1.390 | 0.047 | 0.051 | 0.055 |
| b | 0.350 | 0.380 | 0.410 | 0.014 | 0.015 | 0.016 |
| e | 1.270TYP. | | | 0.050TYP. | | |
| L | 0.559 | 0.635 | 0.711 | 0.022 | 0.025 | 0.028 |
| L1 | 0.424 | 0.500 | 0.576 | 0.017 | 0.020 | 0.023 |
| H | 0.574 | 0.650 | 0.726 | 0.023 | 0.026 | 0.029 |
| θ | 10° | 11° | 12° | 10° | 11° | 12° |
| Φ | 1.150 | 1.200 | 1.250 | 0.045 | 0.047 | 0.049 |

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